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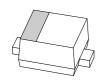
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BB189

UHF variable capacitance diode Rev. 01 — 8 June 2009

Product data sheet

Product profile

1.1 General description

The BB189 is a planar technology variable capacitance diode in a SOD523 ultra small leadless plastic SMD package. The excellent matching performance is achieved by gliding matching and a Direct Matching Assembly (DMA) procedure.

1.2 Features

- Excellent linearity
- Excellent matching to 1.8 % DMA
- Ultra small plastic SMD package
- $C_{d(25V)}$: 2.05 pF; $C_{d(2V)}$ to $C_{d(25V)}$ ratio: 6.3 min.
- Low series resistance

1.3 Applications

- Voltage Controlled Oscillators (VCO)
- Electronic tuning in UHF television tuners

Pinning information 2.

Table 1. **Pinning**

Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	JL
2	anode	1 2	₩
			sym008

^[1] The marking bar indicates the cathode.

Ordering information 3.

Table 2. **Ordering information**

Type number	Package		
	Name	Description	Version
BB189	SC-79	plastic surface-mounted package; 2 leads	SOD523



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4. Marking

Table 3. Marking codes

Type number	Marking code
BB189	4

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{R}	reverse voltage		-	32	V
l _F	forward current		-	20	mA
T _{stg}	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

6. Characteristics

Table 5. Characteristics

 $T_i = 25 \,^{\circ}C$ unless otherwise specified

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _R	reverse current	see Figure 2				
		V _R = 30 V	-	-	10	nA
		V _R = 30 V; T _j = 85 °C	-	-	200	nA
rs	diode series resistance	f = 470 MHz at C _d = 9 pF	-	0.6	0.7	Ω
C _d	diode capacitance	f = 1 MHz; see <u>Figure 1</u> and <u>Figure 3</u>				
		V _R = 2 V	14.15	-	15.75	pF
		V _R = 25 V	1.89	-	2.18	pF
$C_{d(2V)}/C_{d(25V)}$	diode capacitance ratio (2 V to 25 V)	f = 1 MHz	6.3	-	-	
$\Delta C_d/C_d$	diode capacitance matching	$V_R = 2 V \text{ to } 25 V; \text{ in sequence of } 10 \text{ diodes (gliding)}$	-	-	1.8	%

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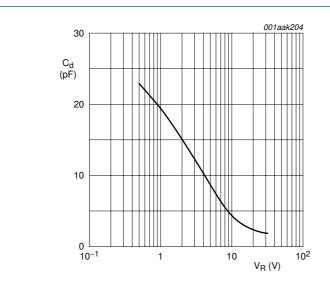


Fig 1. Diode capacitance as a function of reverse voltage; typical values

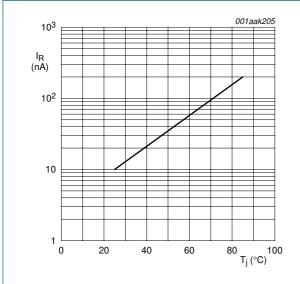


Fig 2. Reverse current as a function of junction temperature; maximum values

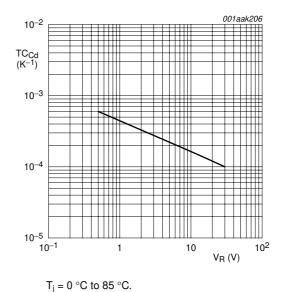


Fig 3. Temperature coefficient of diode capacitance as a function of reverse voltage; typical values

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7. Package outline

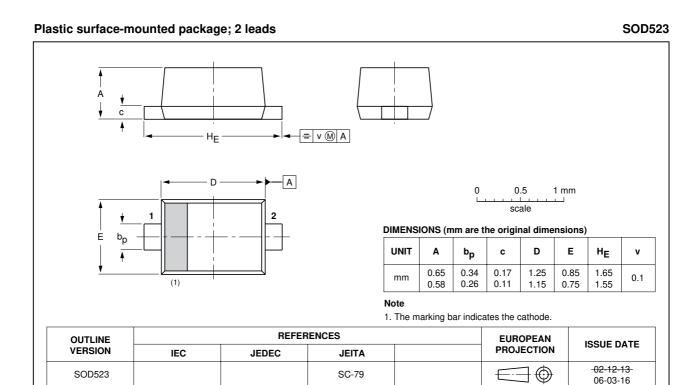


Fig 4. Package outline SOD523 (SC-79)

8. Abbreviations

Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
UHF	Ultra High Frequency

9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB189_1	20090608	Product data sheet	-	-

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10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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